## STN3NF06L



# N-channel 60 V, 0.07 Ω typ., 4 A STripFET™ II Power MOSFET in a SOT-223 package

Datasheet - production data

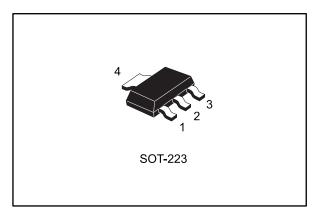
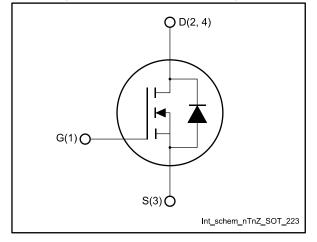


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ID
STN3NF06L	60 V	0.1 Ω	4 A

- Exceptional dv/dt capability
- 100% avalanche tested
- Low threshold drive

### **Applications**

Switching applications

### **Description**

This Power MOSFET series realized with STMicroelectronics unique STripFET™ process is specifically designed to minimize input capacitance and gate charge. It is therefore ideal as a primary switch in advanced high-efficiency isolated DC-DC converters for Telecom and Computer applications. It is also suitable for any application with low gate charge drive requirements.

**Table 1: Device summary** 

Order code	Marking	Package	Packing
STN3NF06L	3NF06L	SOT-223	Tape and reel

Contents STN3NF06L

## **Contents**

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STN3NF06L Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V <sub>DS</sub>	Drain-source voltage	60	V	
V <sub>GS</sub>	Gate-source voltage	±16	V	
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at Tc = 25 °C	4	Α	
I <sub>D</sub>	Drain current (continuous) at T <sub>c</sub> = 100 °C	2.9	Α	
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	16	Α	
Ртот	Total dissipation at T <sub>pcb</sub> = 25 °C 3.3			
dv/dt (3)	Peak diode recovery voltage slope	10	V/ns	
E <sub>AS</sub> <sup>(4)</sup>	Single pulse avalanche energy 200		mJ	
Tj	Operating junction temperature range	55 to 150	°C	
T <sub>stg</sub>	Storage temperature range	- 55 to 150 °C		

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-pcb</sub>	Thermal resistance junction-pcb (1)	38	°C/W
R <sub>thj-pcb</sub>	Thermal resistance junction-pcb <sup>(2)</sup>	100	°C/W

### Notes:

<sup>&</sup>lt;sup>(1)</sup>Current limited by the package.

<sup>&</sup>lt;sup>(2)</sup>Pulse width limited by safe operating area.

 $<sup>^{(3)}</sup>I_{SD} \leq 3$  A, di/dt  $\leq 150$  A/µs, V<sub>DD</sub>  $\leq V_{(BR)DSS}$ 

 $<sup>^{(4)}</sup>$ Starting  $T_j$  = 25 °C,  $I_D$  = 4 A,  $V_{DD}$  = 30 V

 $<sup>\</sup>ensuremath{^{(1)}}\xspace$  When Mounted on FR-4 board 1 inch² pad, 2 oz. of Cu and t <10 s.

<sup>(2)</sup>When mounted on minimum recommended footprint.

Electrical characteristics STN3NF06L

## 2 Electrical characteristics

 $T_C = 25$  °C unless otherwise specified

Table 4: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 250  \mu\text{A}$	60			V
	I <sub>DSS</sub> Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 60 \text{ V}$			1	μΑ
I <sub>DSS</sub>		$V_{GS} = 0 \text{ V}, V_{DS} = 60 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$			10	μΑ
Igss	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1		2.8	V
Static drain-source	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.5 A		0.07	0.10	Ω	
► DS(on)	R <sub>DS(on)</sub> on-resistance	V <sub>GS</sub> = 5 V, I <sub>D</sub> = 1.5 A		0.085	0.12	Ω

#### Notes:

Table 5: Dynamic

Table of Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		ı	340		pF
Coss	Output capacitance	V <sub>DS</sub> =25 V, f=1 MHz, V <sub>GS</sub> =0 V	-	63		pF
Crss	Reverse transfer capacitance	7 V20 -20 V, I=1 IIII I2, V30-0 V	-	30		pF
Qg	Total gate charge	V <sub>DD</sub> = 48 V, I <sub>D</sub> = 3 A	-	7	9	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 0 to 5 V	-	1.5		nC
$Q_{gd}$	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	2.8		nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 1.5 A,	-	9	-	ns
t <sub>r</sub>	Rise time	$R_G = 4.7 \Omega$	-	25	-	ns
t <sub>d(off)</sub>	Turn-off delay time	V <sub>GS</sub> = 5 V (see Figure 13: "Test circuit for resistive load switching times" and Figure 18: "Switching time waveform")	-	20	-	ns
t <sub>f</sub>	Fall time		-	10	-	ns

 $<sup>\</sup>ensuremath{^{(1)}}\mbox{Defined}$  by design, not subject to production test.

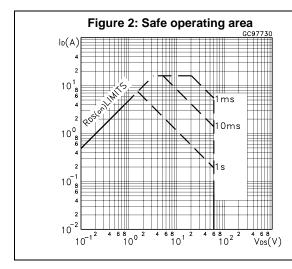
Table 7: Source-drain diode

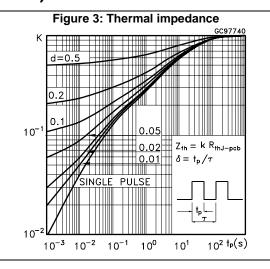
Table 1. Course drain diode						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	I <sub>SD</sub> = 4 A, V <sub>GS</sub> =0 V	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 4 A, di/dt = 100 A/μs,	-	50		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> =25 V, T <sub>j</sub> =150 °C (see <i>Figure 15: "Test circuit for</i>	-	88		nC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	3.5		Α

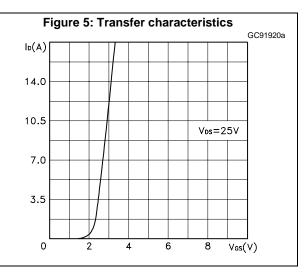
### Notes:

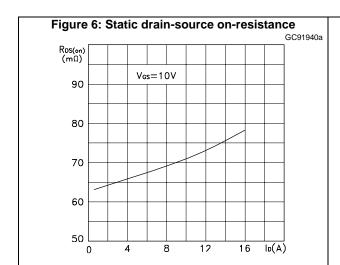
 $<sup>^{(1)}\</sup>text{Pulsed:}$  pulse duration = 300  $\mu\text{s},$  duty cycle 1.5%

## 2.1 Electrical characteristics (curves)









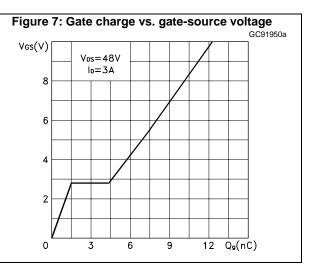


Figure 10: Normalized on-resistance vs temperature

GC91980a

Ros(on)
(norm)

2.0

1.6

1.2

0.8

0.4

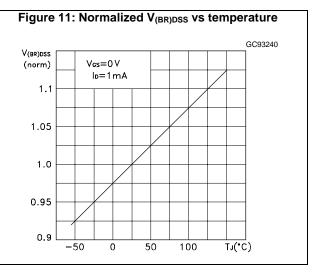
-50

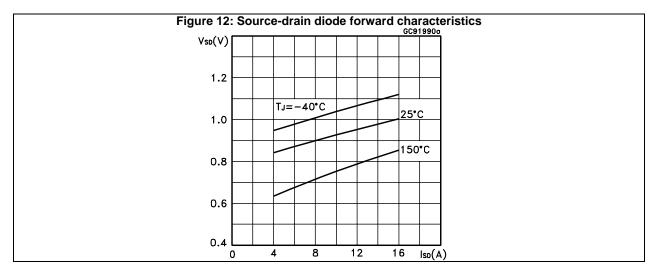
0

50

100

TJ(\*C)





Test circuits STN3NF06L

### 3 Test circuits

Figure 13: Test circuit for resistive load switching times

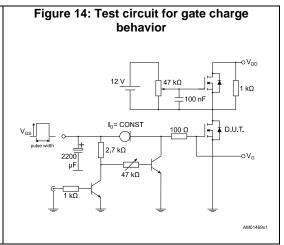
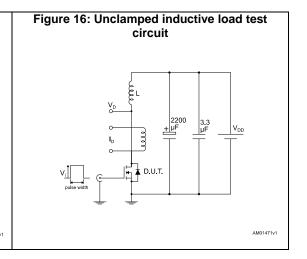
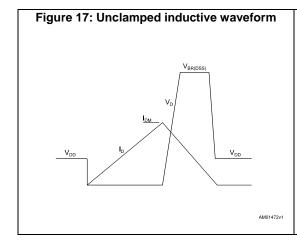
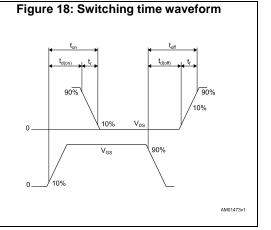


Figure 15: Test circuit for inductive load switching and diode recovery times







## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

## 4.1 SOT-223 package information

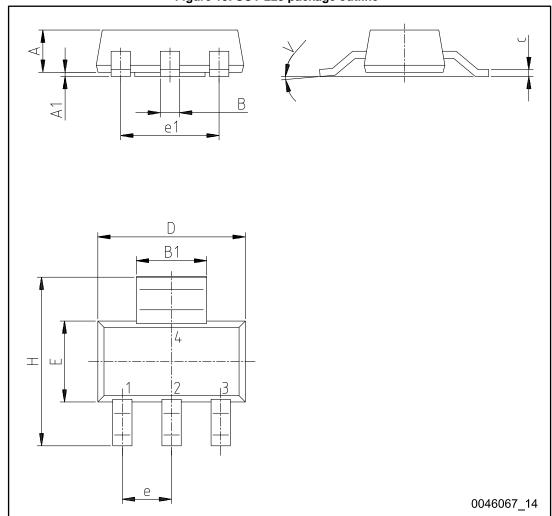
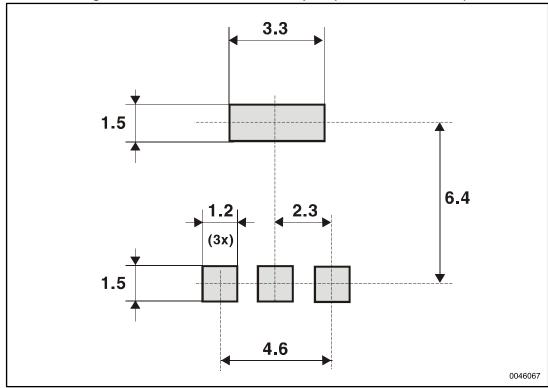


Figure 19: SOT-223 package outline

Table 8: SOT-223 package mechanical data

Dim.	mm				
Dim.	Min.	Тур.	Max.		
A			1.8		
A1	0.02		0.1		
В	0.6	0.7	0.85		
B1	2.9	3	3.15		
С	0.24	0.26	0.35		
D	6.3	6.5	6.7		
е		2.3			
e1		4.6			
Е	3.3	3.5	3.7		
Н	6.7	7.0	7.3		
V			10°		

Figure 20: SOT-223 recommended footprint (dimensions are in mm)



STN3NF06L Revision history

# 5 Revision history

Table 9: Document revision history

Date	Revision	Changes
21-Jun-2004	5	Complete version.
04-Oct-2006	6	New template, no content change.
01-Feb-2007	7	Typo mistake on Table 2.
12-Jun-2008	8	Corrected marking on Table 1
03-Jul-2017	9	Modified internal schematic diagram on cover page. Updated Section 4: "Package information". Minor text changes.

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